

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Lamson, et al.

Serial No.: 09/989,263

Filed:

11/19/01

For:

Examiner: Maldonado, Art Unit:

Docket No.:

TI-3118

2823

Low Capacitance Coupling Wire Bonded Semiconductor Device

Amendment under 37 CFR 1.111

**Assistant Commissioner of Patents** Washington, DC 20231

I share her to be to the second

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on

Michael K. Skrehot, Reg. No. 36,682

-14-02

Dear Sir:

The following amendments and remarks are offered in response to the Examiner's Office Action dated 08/14/02. They are respectfully submitted as a full and complete response to that Action. The Commissioner is hereby requested and authorized to charge any fees necessary for the filing of the enclosed papers to deposit account number 20-0668 of Texas Instruments Incorporated.